

TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE (L^2 - π -MOS $\bar{V}$)

2SJ360

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

- 4 V GATE DRIVE
- Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.55 \Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 0.9 S$ (Typ.)
- Low Leakage Current : $I_{DSS} = -100 \mu A$ (Max.) ($V_{DS} = -60 V$)
- Enhancement-Mode : $V_{th} = -0.8 \sim -2.0 V$
($V_{DS} = -10 V$, $I_D = -1 mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DSS}	-60	V
Drain-Gate Voltage ($R_{GS} = 20 k\Omega$)	V_{DGR}	-60	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	DC	I_D	-1 A
	Pulse	I_{DP}	-3 A
Drain Power Dissipation ($T_a = 25^\circ C$)	P_D	0.5	W
Drain Power Dissipation*	P_D	1.5	W
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55~150	$^\circ C$

* : Mounted on ceramic substrate ($1 \text{ inch}^2 \times 0.8 t$)

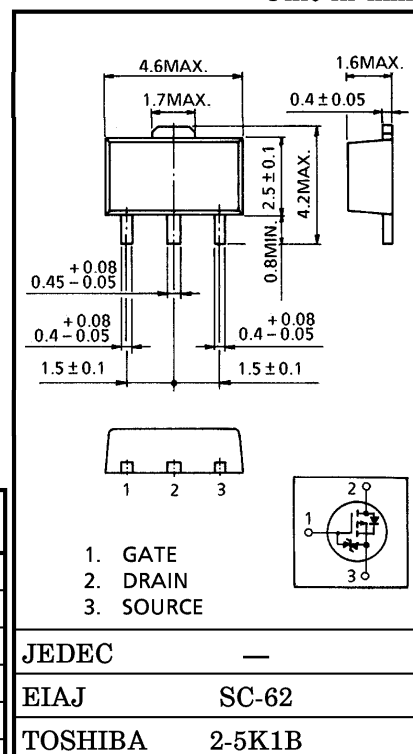
THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel To Ambient	$R_{th(ch-a)}$	250	$^\circ C/W$

This transistor is an electrostatic sensitive device.
Please handle with caution.

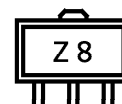
INDUSTRIAL APPLICATIONS

Unit in mm



Weight : 0.05 g (Typ.)

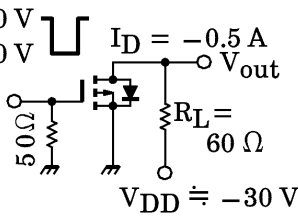
MARKING



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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	± 10	μA
Drain Cut-off Current		I_{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	-100	μA
Drain-Source Breakdown Voltage		$V_{(BR) DSS}$	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	—	-2.0	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = -4 \text{ V}, I_D = -0.5 \text{ A}$	—	0.86	1.2	Ω
			$V_{GS} = -10 \text{ V}, I_D = -0.5 \text{ A}$	—	0.55	0.73	
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = -10 \text{ V}, I_D = -0.5 \text{ A}$	0.5	0.9	—	S
Input Capacitance		C_{iss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}$ $f = 1 \text{ MHz}$	—	155	—	pF
Reverse Transfer Capacitance		C_{rss}		—	20	—	
Output Capacitance		C_{oss}		—	75	—	
Switching Time	Rise Time	t_r	 $V_{GS} = 0 \text{ V} \rightarrow -10 \text{ V}$ $I_D = -0.5 \text{ A}$ $R_L = 60 \Omega$ $V_{DD} \doteq -30 \text{ V}$	—	17	—	ns
	Turn-on Time	t_{on}		—	20	—	
	Fall Time	t_f		—	20	—	
	Turn-off Time	t_{off}		—	100	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} \doteq -48 \text{ V}, V_{GS} = -10 \text{ V}$ $I_D = -1 \text{ A}$	—	6.5	—	nC
Gate-Source Charge		Q_{gs}		—	4.5	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	2.0	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	-1	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	-3	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = -1 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	1.7	V
Reverse Recovery Time	t_{rr}	$I_{DR} = -1 \text{ A}, V_{GS} = 0 \text{ V}$	—	50	—	ns
Reverse Recovery Charge	Q_{rr}	$dI_{DR} / dt = 50 \text{ A} / \mu\text{s}$	—	50	—	μC

